

Insulated enclosure, top+bottom open, HxWxD=375x375x175mm

Powering Business Worldwide

Part no. CI44-150 Article no. 017198

Delivery program

Delivery program		
Dimensions	mm	205
Product range		Ci insulated enclosures
Basic function		Basic enclosures
Product function		Distribution board enclosure without cable gland plates
Single unit/Complete unit		Single unit
Degree of Protection		IP65
Description		Sealable cover fasteners Sides closed, but with full area knockout Open top and bottom
Type cover		Transparent
Width	mm	375
Height	mm	375
Depth	mm	175
Mounting depth with mounting plate	mm	150
Mounting depth for mounting rail 7.5 mm height	mm	142.5
Mounting depth for mounting rail 15 mm height	mm	135
Enclosure depth		
Legend for the graphic		Dimensions from top: Mounting depth with mounting plate Mounting depth for mounting rail 7.5 mm height Mounting depth for mounting rail 15 mm height Enclosure depth
Enclosure depth	mm	

Notes

Distribution board with/without gland plates fitted

• Cover transparent, cover fasteners can be sealed

Ci distribution board enclosure without cable gland plates

- Degree of protection IP65
- Sides closed, but with full area knockout, open top and bottom

KST distribution board enclosure with cable gland plates fitted

- Degree of protection IP65 from below
- Sides closed, but with full area knockout, open at top
- Fitting of cable supports in the distribution board with wedge-lock fastner
- Gland plate can be split, cables can be inserted from the front

Technical data General

General		
Standards		IEC/EN 60529 EN 50262 DIN 43656 DIN 43660 EN 60439-4 for ClX individual enclosures with combined distribution boards from Ci enclosures up to 680 A. Can thus be used for socket combinations and as component for construction site distribution boards.
Climatic proofing		Damp heat, constant, to IEC 60068-2-78 Damp heat, cyclic, to IEC 60068-2-30
Ambient temperature	°C	-40 - +80
Ambient temperature		
Mean value over 24 hours	°C	35
Limit values	°C	
Ambient temperature limit value min.	°C	-5
Ambient air temperature, limit values max.	°C	40
Degree of Protection		IP65
Protection type		IP65 (Enclosure) IP65 (KST cable entries from below) IP64 (KST cable entries from above) IP00 (Cable entry open)
Power loss		
Max. radiated heat dissipation with separate mounting, ambient air temperature +20 °C	W	68
Max. radiated heat dissipation in distribution board combination to VDE 0660 Part 500	W	54
Notes		When calculating the heat dissipation, the quadratic relationship of current with the rated diversity factor a must be considered. $P_v = I_2 \times R$ $P_v' = P_v \times a^2$ If no data is available concerning the load relationships of the individual circuits, the rated diversity factor is selected conform to VDE 0660 Part 500.
additional technical data for UL-/CSA- approved devices		see UL-report File No. E54120
Components		Switchgear assembly components are type-tested. They are available individually for the self-assembly of switchgear installations, distribution boards and control panels.
Devices that can be fitted		The reference values indicated in the table apply to the basic elements of the distribution board. As far as devices, terminals etc. fitted into the enclosures are concerned, their own specific technical data and rated values apply.
Standards		
TTA - Type Tested Assemblies		IEC/EN 60439-1, VDE 0660 Part 500
Low-voltage fuses		IEC/EN 60269, VDE 0636
Type test		VDE 0660 Part 500, IEC/EN 60439-1
Creepage and clearance distances		III/3 to IEC/EN 60439-1
Flammability characteristics - Glow rod test		VDE 0304 Part 3 level IIb, level IIb to IEC 60707
Regulation for the fire resistance tests of electrical products, their modules and components, glow wire test		VDE 0471 Part 2
Operating and ambient conditions to VDE 0660 Part 500		
Ambient temperature		
Mean value over 24 hours	°C	35
Limit values	°C	-5 40
Indoor installation		
Relative humidity		90 % (at 20°C) 50% (at 40°C)
Altitude	m	Max. 2000
Protection type		IP65 (Enclosure) IP65 (KST cable entries from below) IP64 (KST cable entries from above) IP00 (Cable entry open)
Mounting grid	mm	25 (DIN 43660)
Colour		
Base		RAL 7032, pebble grey
Housing body		Transparent, colourless or RAL 7032, pebble grey
		ClNA: Transparent cover, opaque

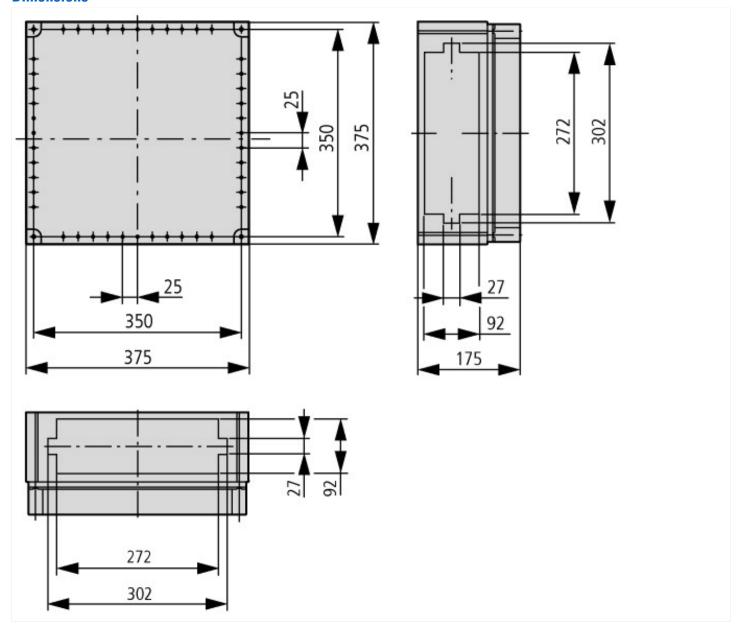
Surface finish		Galvanized
		Passivated
Material characteristics		
Material		glass-fibre reinforced polycarbonate (base) non-reinforced polycarbonate (cover) Halogen free
Surface finish		Galvanized Passivated
Colour		RAL 7032, pebble grey (base) transparent, opaque (cover)
Colour		
Base		RAL 7032, pebble grey
Housing body		Transparent, colourless or RAL 7032, pebble grey
Material properties		
Electrical		
Track resistance		KB160, KC175 (base, to IEC 60112) KB100, KC200 (cover, to IEC 60112)
Surface resistance to IEC 60093	$\Omega \times 10^{13}$	1
Dielectric strength to IEC 60243-1	kV/mm	30
Thermal		
Temperature resistant		-40 °C - 120 °C (enclosure) 85 °C (enclosure bolt) 80 °C (gasket)
Mechanical		
Impact resistance		IK10 according to EN 50102
Loading capacity	kg/m ²	20
Chemical resistance		
Chemical resistant		Resistant against: Acids < 10 %, mineral oil, alcohol, gasoline, greases, salt solutions Partly resistant to: Acids > 10 % Not resistant to: alkalis, benzene
Atmospheric		
Saline spray		IEC 60068-2-11
UV resistance		Beneath protective shield
Water consumption to DIN EN ISO 62	%	0.29
Flammability characteristics		
Flammability classification according to UL94		V1 (base) V2 (cover)

Design verification as per IEC/EN 61439

Design verification as per IEC/EN 01439			
Technical data for design verification			
Heat dissipation, at an ambient temperature of 35°C, delta T: 20 degrees, calculated as per IEC 60890			
Individual enclosure for wall mounting	P_{V}	CO	27
Starting enclosure for wall mounting	P_{V}	CO	26
Middle enclosure for wall mounting	P_{V}	CO	24
Heat dissipation, at an ambient temperature of 35°C, delta T: 35 degrees, calculated as per IEC 60890			
Individual enclosure for wall mounting	P_{V}	CO	54
Starting enclosure for wall mounting	P_{V}	CO	51
Middle enclosure for wall mounting	P_{V}	CO	48
IEC/EN 61439 design verification			
10.2 Strength of materials and parts			
10.2.2 Corrosion resistance			Meets the product standard's requirements.
10.2.3.1 Verification of thermal stability of enclosures			Meets the product standard's requirements.
10.2.3.2 Verification of resistance of insulating materials to normal heat			Meets the product standard's requirements.
10.2.3.3 Verification of resistance of insulating materials to abnormal heat and fire due to internal electric effects			Lower part: 960 °C / cover: 850 °C; meets the product standard's requirements.
10.2.4 Resistance to ultra-violet (UV) radiation			Not relevant to indoor installations.
10.2.5 Lifting			20 kg per enclosure with support frame and lifting aid met; assembled and secured as per the latest applicable instruction leaflet.

10.2.6 Mechanical impact 10.2.7 Inscriptions Meets the product standard's requirements. 10.3 Degree of protection of ASSEMBLIES 10.4 Clearances and creepage distances 10.5 Protection against electric shock 10.6 Incorporation of switching devices and components 10.7 Internal electrical circuits and connections 10.8 Connections for external conductors 10.9 Insulation properties 10.9.2 Power-frequency electric strength 10.9.3 Impulse withstand voltage 10.9.4 Testing of enclosures made of insulating material 10.10 Temperature rise 10.10 Temperature rise 10.11 Short-circuit rating 10.12 Electromagnetic compatibility 10.13 Mechanical function Meets the product standard's requirements. Meets the product standard's responsibility. Is the panel builder's responsibility. Is the panel builder's responsibility. Is the panel builder is responsibility and for the temperature rise calculation. Eaton will provide heat dissipation data for the devices. 10.11 Short-circuit rating 10.12 Electromagnetic compatibility 10.13 Mechanical function Meets the product standard's requirements.		
10.3 Degree of protection of ASSEMBLIES 10.4 Clearances and creepage distances 10.5 Protection against electric shock 10.6 Incorporation of switching devices and components 10.7 Internal electrical circuits and connections 10.8 Connections for external conductors 10.9 Insulation properties 10.9.2 Power-frequency electric strength 10.9.3 Impulse withstand voltage 10.9.4 Testing of enclosures made of insulating material 10.10 Temperature rise 10.10 Temperature rise 10.11 Short-circuit rating 10.12 Electromagnetic compatibility Is the panel builder's responsibility. Is the panel builder's responsibility of the temperature rise calculation. Eaton will provide heat dissipation data for the devices.	10.2.6 Mechanical impact	IK10
10.4 Clearances and creepage distances 10.5 Protection against electric shock 10.6 Incorporation of switching devices and components 10.7 Internal electrical circuits and connections 10.8 Connections for external conductors 10.9 Insulation properties 10.9.2 Power-frequency electric strength 10.9.3 Impulse withstand voltage 10.9.4 Testing of enclosures made of insulating material 10.10 Temperature rise 10.11 Short-circuit rating 10.12 Electromagnetic compatibility 1 Is the panel builder's responsibility.	10.2.7 Inscriptions	Meets the product standard's requirements.
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10.9 Insulation properties 10.9.2 Power-frequency electric strength 10.9.3 Impulse withstand voltage 8 kV 10.9.4 Testing of enclosures made of insulating material 10.10 Temperature rise 10.11 Short-circuit rating 10.12 Electromagnetic compatibility 10.12 Electromagnetic compatibility 10.15 Insulation properties U _i = 1000 V AC 8 kV Meets the product standard's requirements. The panel builder is responsible for the temperature rise calculation. Eaton will provide heat dissipation data for the devices. 10.11 Short-circuit rating 10.12 Electromagnetic compatibility.	10.7 Internal electrical circuits and connections	Is the panel builder's responsibility.
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10.12 Electromagnetic compatibility Is the panel builder's responsibility.	10.10 Temperature rise	
	10.11 Short-circuit rating	Is the panel builder's responsibility.
10.13 Mechanical function Meets the product standard's requirements.	10.12 Electromagnetic compatibility	Is the panel builder's responsibility.
	10.13 Mechanical function	Meets the product standard's requirements.

Dimensions



Additional product information (links)

Manufacturer's Declaration CI-RoHS	ftp://ftp.moeller.net/DOCUMENTATION/PDF/2013-01-31_Ci_RoHS.pdf
Declaration of conformity	ftp://ftp.moeller.net/DOCUMENTATION/PDF/ci_ce.pdf